

<<材料科学与工程基础>>

图书基本信息

书名：<<材料科学与工程基础>>

13位ISBN编号：9787502541781

10位ISBN编号：7502541780

出版时间：2004-1

出版时间：化学工业出版社

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页数：412

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内容概要

该书具有很完整的材料与工程体系，无论作为材料专业的教材，还是科技书，都具有很强的实用价值。

<<材料科学与工程基础>>

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书籍目录

1. Introduction 1.1 Historical Perspective 1.2 Materials Science and Engineering 1.3 Why Study Materials Science and Engineering? 1.4 Classification of Materials 1.5 Advanced Materials 1.6 Modern Materials ' Needs2. Atomic Structure and Interatomic Bonding 2.1 Introduction 2.2 Fundamental Concepts 2.3 Electrons in Atoms 2.4 The Periodic Table 2.5 Bonding Forces and Energies 2.6 Primary Interatomic Bonds 2.7 Secondary Bonding or Van der Waals Bonding 2.8 Molecules3. Structures of Metals and Ceramics 3.1 Introduction 3.2 Fundamental 3.3 Unit Cells 3.4 Metallic Crystal Structures 3.5 Density Computations-Metals 3.6 Ceramic Crystal Structures 3.7 Density Computations-Ceramics 3.8 Silicate Ceramics 3.9 Carbon 3.10 Polymorphism and Allotropy 3.11 Crystal Systems 3.12 Crystallographic Directions 3.13 Crystallographic Planes 3.14 Linear and Planar Atomic Densities 3.15 Close-Packed Crystal Structures 3.16 Single Crystals 3.17 Polycrystalline Materials 3.18 Anisotropy 3.19 X-Ray Diffraction:Determination of Crystal Structures(CD-ROM)S-6 3.20 Noncrystalline solids4. Polymer Structures 4.1 Introduction 4.2 Hydrocarbon Molecules 4.3 Polymer Molecules 4.4 The Chemistry of Polymer Molecules 4.5 Molecular Weight 4.6 Molecular Shape 4.7 Molecular Structure 4.8 Molecular Configurations(CD-ROM)S-11 4.9 Thermoplastic and Thermosetting Polymers 4.10 Copolymers 4.11 Polymer Crystals 4.12 Polymer Crystals5. Imperfections in Solids 5.1 Introduction 5.2 Point Defects in Metals 5.3 Point Defects in Ceramics 5.4 Impurities in Solids 5.5 Point Defects in Polymers 5.6 Specification of Composition 5.7 Dislocations-Linear Defects 5.8 Interfacial Defects 5.9 Bulk or Volume Defects 5.10 Atomic Vibrations 5.11 General 5.12 Microscopic Techniques 5.13 Grain Size Determination6. Diffusion 6.1 Introduction 6.2 Diffusion Mechanisms 6.3 Steady-State Diffusion 6.4 Nonsteady-State Diffusion 6.5 Factors That Influence Diffusion 6.6 Other Diffusion Paths 6.7 Diffusion in Ionic and Polymeric Materials7. Mechanical Properties 7.1 Introduction 7.2 Concepts of Stress and Strain 7.3 Stress-Strain Behavior 7.4 Anelasticity 7.5 Elastic Properties of Materials 7.6 Tensile Properties 7.7 True Stress and Strain 7.8 Elastic Recovery During Plastic Deformation 7.9 Compressive, Shear, and Torsional Deformation 7.10 Flexural Strength 7.11 Elastic Behavior 7.12 Influence of Porosity on the Mechanical Properties of Ceramics(CD-ROM)S-22 7.13 Stress-Strain Behavior 7.14 Macroscopic Deformation 7.15 Viscoelasticity(CD-ROM)S-22 7.16 Hardness 7.17 Hardness of Ceramic Materials 7.18 Tear Strength and Hardness of Polymers 7.19 Variability of Material Properties 7.20 Design/Safety Factors8. Deformation and Strengthening Mechanisms 8.1 Introduction 8.2 Historical 8.3 Basic Concepts of Dislocations 8.4 Characteristics of Dislocations 8.5 Slip Systems 8.6 Slip in Single Crystals(CD-ROM)S-31 8.7 Plastic Deformation of Polycrystalline Metals 8.8 Deformation by Twinning(CD-ROM)S-34 8.9 Strengthening by Grain Size Reduction 8.10 Solid-Solution Strengthening 8.12 Recovery 8.13 Recrystallization 8.14 Grain Growth 8.15 Crystalline Ceramics 8.16 Noncrystalline Ceramics 8.17 Deformation of Semicrystalline Polymers 8.18 Factors That Influence the Mechanical Properties of Semicrystalline Polymers[Detailed Version (CD-ROM)]S-35 8.19 Deformation of Elastomers9. Failure 9.1 Introduction 9.2 Fundamentals of Fracture 9.3 Ductile Fracture 9.4 Brittle Fracture 9.5a Principles of Fracture Mechanics[Detailed Version (CD-ROM)]S-38 9.6 Brittle Fracture of Ceramics 9.7 Fracture of Polymers 9.8 Impact Fracture Testing 9.9 Cyclic Stresses 9.10 The S-N Curve 9.11 Fatigue in Polymeric Materials 9.12a Crack Initiation and Propagation[Detailed Version (CD-ROM)]S-54 9.13 Crack Propagation Rate 9.14 Factors That Affect Fatigue Life 9.15 Environmental Effects(CD-ROM)S-62 9.16 Generalized Creep Behavior 9.17b Stress and Temperature Effects (Concise Version)S-65 9.18 Data Extrapolation Methods 9.19 Alloys for High-Temperature Use 9.20 Creep in Ceramic and Polymeric Materials10. Phase Diagrams 10.1 Introduction 10.2 Solubility 10.3 Phases 10.4 Microstructure 10.5 Phase Equilibria 10.6 Binary Isomorphous Systems 10.7 Interpretation of Phase Diagrams 10.8 Development of Microstructure in Isomorphous Alloys (CD-ROM)S-67 10.9 Mechanical Properties of Isomorphous Alloys 10.10 Binary Eutectic Systems 10.11 Development of Microstructure in Eutectic Alloys(CD-ROM)S-70 10.12 Equilibrium Diagrams Having Intermediate Phases or Compounds 10.13 Eutectoid and Peritectic Reactions 10.14 Congruent Phase Transformations 10.15 Ceramic Phase Diagrams(CD-ROM)S-77 10.16 Ternary Phase Diagrams 10.17 The Gibbs Phase Rule (CD-ROM)S-81 10.18 The Iron-Iron Carbide (Fe-Fe₃C)Phase Diagram 10.19 Development of

Microstructures in Iron-Carbon Alloys 10.20 The Influence of Other Alloying Elements(CD-ROM)S-8311 Phase Transformations 11.1 Introduction 11.2 Basic Concepts 11.3 The Kinetics of Solid-State 11.4 Multiphase Transformations 11.5 Isothermal Transformation 11.6 Continuous Cooling Transformation Diagrams(CD-ROM)S-85 11.7 Mechanical Behavior of Iron-Carbon Alloys 11.8 Tempered Martensite 11.9 Review of Phase Transformations for Iron-Carbon Alloys 11.10 Heat Treatments 11.11 Mechanism of Hardening 11.12 Miscellaneous Considerations 11.13 Crystallization 11.14 Melting 11.15 The Glass Transition 11.16 Melting and Glass Transition Temperatures 11.17 Factors That Influence Melting and Glass Transition Temperatures (CD-ROM)S-8712.Electrical Properties 12.1 Introduction 12.2 Ohm ' s Law 12.3 Electrical Conductivity 12.4 Electronic and Ionic Conduction 12.5 Energy Band Structures in Solids 12.6 Conduction in Terms of Band and Atomic Bonding Models 12.7 Electron Mobility 12.8 Electrical Resistivity of Metals 12.9 Electrical Characteristics of Commercial Alloys 12.10 Intrinsic Semiconduction 12.11 Extrinsic Semiconduction 12.15 Conduction in Ionic Materials 12.16 Electrical Properties of Polymers14.Synthesis,Fabrication,and Processing of Materials (CD-ROM)S-118 14.1 Introduction S-119 14.2 Forming Operations S-119 14.3 Casting 14.4 Miscellaneous Techniques 14.5 Annealing Processes 14.6 Heat Treatment of Steels 14.7 Fabrication and Processing of Glasses 14.8 Fabrication of Clay Products 14.9 Powder Pressing 14.10 Tape Casting 14.11 Polymerization 14.12 Polymer Additives 14.13 Forming Techniques for Plastics 14.14 Fabrication of Elastomers 14.15 Fabrication of Fibers and Films15.Composites(CD-ROM)S-162 15.1 Introduction 15.2 Large-Particle Composites 15.3 Dispersion-Strengthened Composites 15.4 Influence of Fiber Length 15.5 Influence of Fiber Orientation and Concentration 15.6 The Matrix Phase 15.7 The Matrix Phase 15.8 Polymer-Matrix Composites 15.9 Metal-Matrix Composites 15.10 Ceramic-Matrix Composites 15.11 Carbon-Carbon Composites 15.12 Hybrid Composites 15.13 Processing of Fiber-Reinforced Composites 15.14 Laminar Composites 15.15 Sandwich Panels16.Corrosion and Degradation of Materials (CD-ROM) 16.1 Introduction 16.2 Electrochemical Considerations 16.3 Corrosion Rates 16.4 Prediction of Corrosion Rates 16.5 Passivity 16.6 Environmental Effects 16.7 Forms of Corrosion 16.8 Corrosion Environments 16.9 Corrosion Prevention 16.10 Oxidation 16.11 Swelling and Dissolution 16.12 Bond Rupture 16.13 Weathering17.Thermal Properties(CD-ROM) 17.1 Introduction 17.2 Heat Capacity 17.3 Thermal Expansion 17.4 Thermal Conductivity 17.5 Thermal Stresses18.Magnetic Properties 18.1 Introduction 18.2 Basic Concepts 18.3 Diamagnetism and Paramagnetism 18.4 Ferromagnetism 18.5 Antiferromagnetism and Ferrimagnetism 18.6 The Influence of Temperature on Magnetic Behavior 18.7 Domains and Hysteresis 18.8 Soft Magnetic Materials 18.9 Hard Magnetic Materials 18.10 Magnetic Storage 18.11 Superconductivity19.Optical Properties(CD-ROM) 19.1 Introduction 19.2 Electromagnetic Radiation 19.3 Light Interactions with Solids 19.4 Atomic and Electronic Interactions 19.5 Refraction 19.6 Reflection 19.7 Absorption 19.8 Transmission 19.9 Color 19.10 Opacity and Translucency in Insulators 19.11 Luminescence 19.12 Photoconductivity 19.13 Lasers 19.14 Optical Fibers in Communications20.Materials Selection and Design Considerations(CD-ROM) 20.1 Introduction 20.2 Strength 20.3 Other Property Considerations and the Final Decision 20.4 Introduction 20.5 Automobile Valve Spring 20.6 Anatomy of the Hip Joint 20.7 Material Requirements 20.8 Materials Employed 20.9 Introduction 20.10 Thermal Protection System-Design Requirements 20.11 Thermal Protection System-Components 20.12 Introduction 20.13 Leadframe Design and Materials 20.14 Die Bonding 20.15 Wire Bonding 20.16 Package Encapsulation 20.17 Tape Automated Bonding21.Economic,Environmental,and Societal Issues in Materials Science and Engineering 21.1 Introduction 21.2 Component Design 21.3 Materials 21.4 Manufacturing Techniques 21.5 Recycling Issues in Materials Science and Engineering

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